DATA SHEET



4-PIN SOP PHOTOCOUPLER OPERATING AMBIENT TEMPERATURE 110°C -NEPOC Series-

DESCRIPTION

NEC

The PS2761B-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor.

This package is mounted in a plastic SOP (Small Outline Package) for high density applications.

The package has shield effect to cut off ambient light.

FEATURES

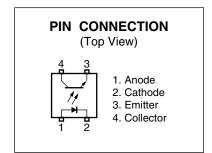
- Operating ambient temperature: 110°C
- Isolation distance (0.4 mm MIN.)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- SOP (Small Outline Package) type
- High-speed switching (tr = 4 μ s TYP., tr = 5 μ s TYP.)
- Ordering number of taping product: PS2761B-1-F3: 3 500 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: No. E72422
 - CSA approved: No. CA 101391
 - BSI approved: No. 8947, 8948
 - SEMKO approved: No. 700105
 - NEMKO approved: No. P07207735
 - DEMKO approved: No. 314212
 - FIMKO approved: No. FI 23239
- DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40008902 (Option)

APPLICATIONS

- Power supply
- Hybrid IC

<R>

Programmable logic controllers



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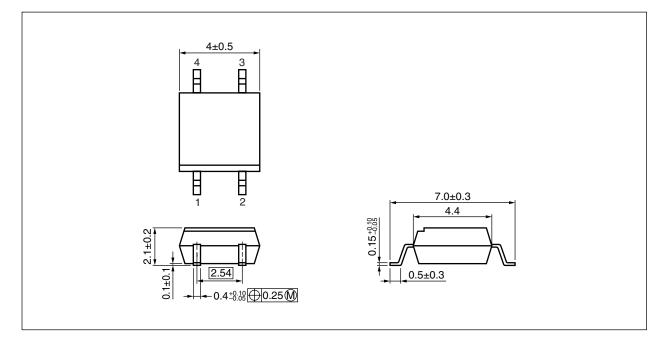
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The mark <R> shows major revised points. © NEC Elec

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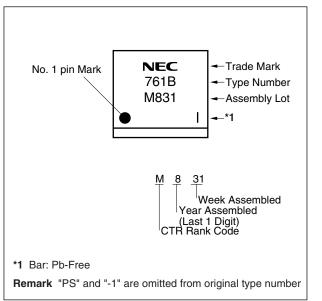
The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (Unit: mm)

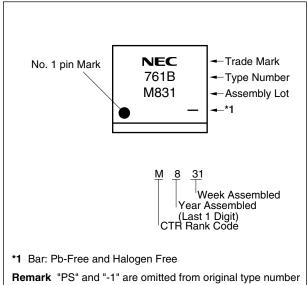


<R> MARKING EXAMPLE

Pb-Free



Special version (Pb-Free and Halogen Free)



PHOTOCOUPLER CONSTRUCTION

| Parameter | PS2761B-1 |
|--------------------------------|-----------|
| Air Distance (MIN.) | 5 mm |
| Outer Creepage Distance (MIN.) | 5 mm |
| Isolation Distance (MIN.) | 0.4 mm |

<R> ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number ^{*1} |
|----------------|-------------------|---------------------------------|------------------------------|-----------------------------|--|
| PS2761B-1 | PS2761B-1-A | Pb-Free | Magazine case 100 pcs | Standard products | PS2761B-1 |
| PS2761B-1-F3 | PS2761B-1-F3-A | | Embossed Tape 3 500 pcs/reel | (UL, CSA, BSI, | |
| | | | | SEMKO, NEMKO, | |
| | | | | DEMKO, FIMKO | |
| | | | | approved) | |
| PS2761B-1-V | PS2761B-1-V-A | | Magazine case 100 pcs | DIN EN60747-5-2 | |
| PS2761B-1-V-F3 | PS2761B-1-V-F3-A | | Embossed Tape 3 500 pcs/reel | (VDE0884 Part2) | |
| | | | | Approved (Option) | |
| PS2761B-1 | PS2761B-1Y-A | Special version | Magazine case 100 pcs | Standard products | PS2761B-1 |
| PS2761B-1-F3 | PS2761B-1Y-F3-A | (Pb-Free and | Embossed Tape 3 500 pcs/reel | (UL, CSA, BSI, | |
| | | Halogen Free) | | SEMKO, NEMKO, | |
| | | | | DEMKO, FIMKO | |
| | | | | approved) | |
| PS2761B-1-V | PS2761B-1Y-V-A | | Magazine case 100 pcs | DIN EN60747-5-2 | |
| PS2761B-1-V-F3 | PS2761B-1Y-V-F3-A | | Embossed Tape 3 500 pcs/reel | (VDE0884 Part2) | |
| | | | | Approved (Option) | |

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

| Parameter | | Symbol | Ratings | Unit |
|---------------------------------|------------------------------------|--------|-------------|---------|
| Diode | Forward Current (DC) | lF | 25 | mA |
| | Reverse Voltage | VR | 6 | V |
| | Power Dissipation Derating | ⊿P₀/°C | 0.8 | mW/°C |
| | Power Dissipation | PD | 80 | mW |
| | Peak Forward Current ^{*1} | IFP | 1.0 | А |
| Transistor | Collector to Emitter Voltage | VCEO | 70 | V |
| | Emitter to Collector Voltage | VECO | 5 | V |
| | Collector Current | lc | 40 | mA |
| | Power Dissipation Derating | ⊿Pc/°C | 1.5 | mW/°C |
| | Power Dissipation | Pc | 150 | mW |
| Isolation Voltage ^{*2} | | BV | 3 750 | Vr.m.s. |
| Operating Ambient Temperature | | TA | –55 to +110 | °C |
| Storage Temperature | | Tstg | –55 to +150 | °C |

***1** PW = 100 μs, Duty Cycle = 1%

^{*2} AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.

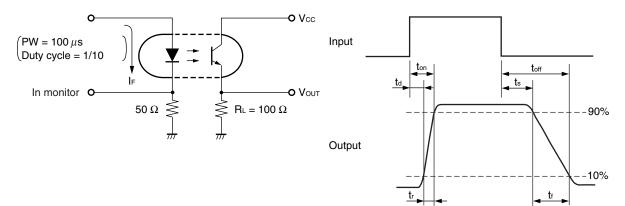
| | Parameter | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|------------|--------------------------------------|-----------|---|------------------|------|------|------|
| Diode | Forward Voltage | VF | IF = 5 mA | | 1.1 | 1.4 | V |
| | Reverse Current | IR | $V_{R} = 5 V$ | | | 5 | μA |
| | Terminal Capacitance | Ct | V = 0 V, f = 1 MHz | | 15 | | pF |
| Transistor | Collector to Emitter Dark Current | Iceo | IF = 0 mA, VCE = 24 V | | | 100 | nA |
| Coupled | Current Transfer Ratio | CTR | IF = 5 mA, Vce = 5 V | 50 | 100 | 400 | % |
| | (Ic/IF) ^{*1} | | IF = 1 mA, Vce = 5 V | 10 | 50 | | |
| | Collector Saturation Voltage | VCE (sat) | IF = 10 mA, Ic = 2 mA | | | 0.3 | V |
| | Isolation Resistance | Ri-o | VI-O = 1 kVDC | 10 ¹¹ | | | Ω |
| | Isolation Capacitance | CI-0 | V = 0 V, f = 1 MHz | | 0.4 | | pF |
| | Rise Time ^{⁺₂} | tr | $V_{CC} = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ R}_{L} = 100 \Omega$ | | 4 | | μs |
| | Fall Time ² | tr | | | 5 | | |

ELECTRICAL CHARACTERISTICS (TA = 25°C)

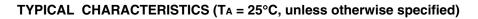
*1 CTR rank

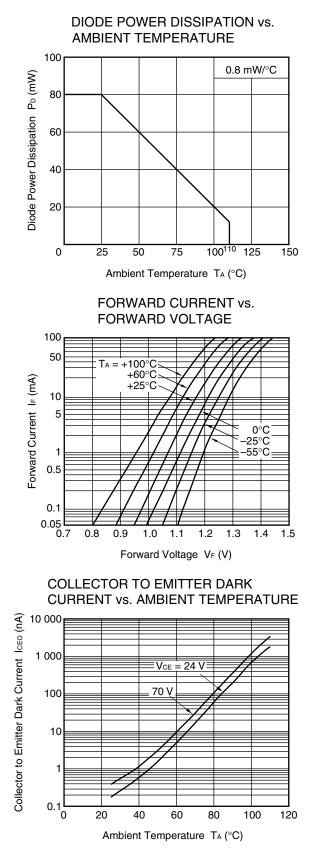
| CTR rank | CTR (%) | Conditions |
|----------|------------|--|
| К | 200 to 400 | IF = 5 mA, VCE = 5 V |
| | 40 to | IF = 1 mA, VCE = 5 V |
| L | 100 to 300 | IF = 5 mA, VCE = 5 V |
| | 20 to | $I_F = 1 \text{ mA}, V_{CE} = 5 \text{ V}$ |
| М | 50 to 150 | IF = 5 mA, VCE = 5 V |
| | 10 to | IF = 1 mA, VCE = 5 V |
| Ν | 50 to 400 | IF = 5 mA, VCE = 5 V |
| | 10 to | $I_F = 1 \text{ mA}, V_{CE} = 5 \text{ V}$ |

*2 Test circuit for switching time



1.5 mW/°C

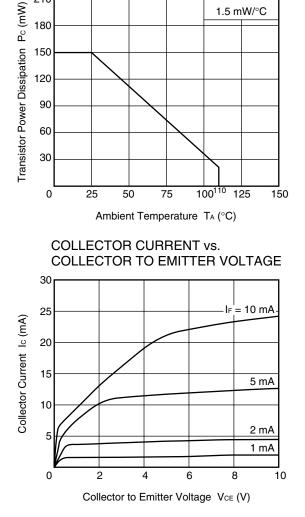




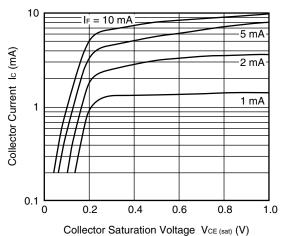


210

180



COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE



Remark The graphs indicate nominal characteristics.

100 120

100

00

1 000

300

100

NORMALIZED CURRENT TRANSFER

RATIO vs. AMBIENT TEMPERATURE

2109

Ambient Temperature TA (°C)

SWITCHING TIME vs. LOAD RESISTANCE

ts

-tr

td

10

Load Resistance RL (kΩ)

FREQUENCY RESPONSE

 $|\mathbf{R}| = 1 \, \mathrm{kC}$

10

Frequency f (kHz)

1.4

1.2

1.0

0.8

0.6

0.4

0.2

0

1 000

100

10

5

0

-5

-10

-15

-20

_25∟ 0.1

IF = 5 mA VCE = 5 V

1

Vormalized Gain Gv

Switching Time t (μ s)

CTR@100%

Normalized to 1.0

 $I_F = 5 \text{ mA}, V_{CE} = 5 \text{ V}$

 $I_F = 5 \text{ mA}, \text{ Vcc} = 5 \text{ V},$

CTR = 236%

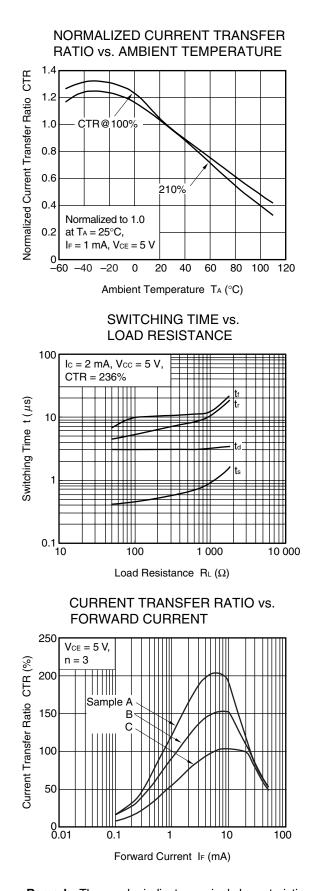
0 20 40 60 80

at $T_A = 25^{\circ}C_{,a}$

-60 -40 -20

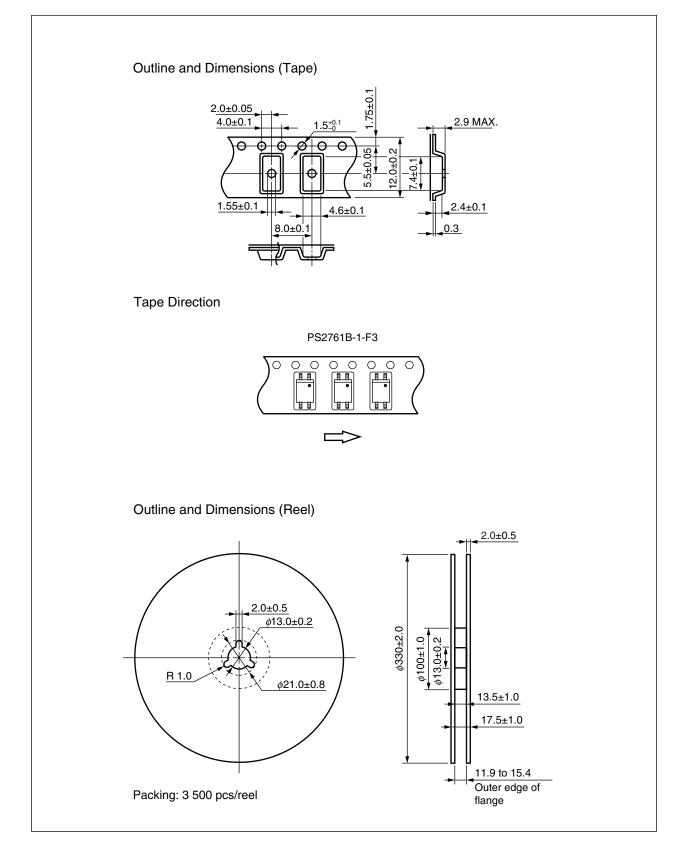
CTR

Normalized Current Transfer Ratio

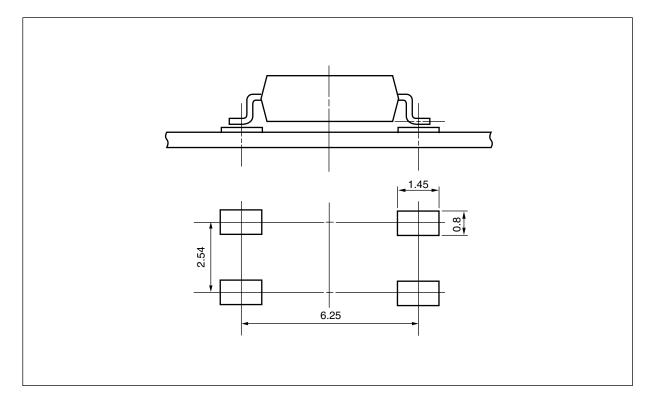




TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



 $\label{eq:result} \textbf{Remark} \hspace{0.2cm} \text{All dimensions in this figure must be evaluated before use}.$

NOTES ON HANDLING

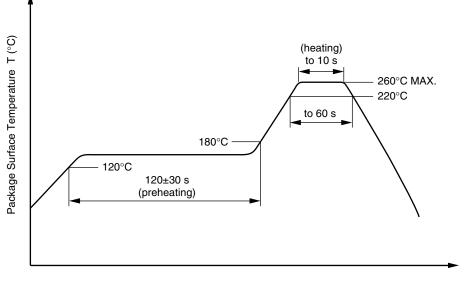
1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

| Peak temperature (lead part temperature) | 350°C or below |
|--|---|
| Time (each pins) | 3 seconds or less |
| • Flux | Rosin flux containing small amount of chlorine (The flux with a |
| | maximum chlorine content of 0.2 Wt% is recommended.) |

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

<R> 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

<R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter | Symbol | Spec. | Unit |
|---|----------------------|--------------------------------------|--|
| Climatic test class (IEC 60068-1/DIN EN 60068-1) | | 55/110/21 | |
| Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{\text{IORM}}, P_{d} < 5 \text{ pC}$ | Uiorm Upr | 707 1 060 | V _{peak} V _{peak} |
| Test voltage (partial discharge test, procedure b for all devices) U_{pr} = 1.875 \times U_{IORM}, Pd < 5 pC | Upr | 1 325 | Vpeak |
| Highest permissible overvoltage | Utr | 6 000 | Vpeak |
| Degree of pollution (DIN EN 60664-1 VDE0110 Part 1) | | 2 | |
| Clearance distance | | >5.0 | mm |
| Creepage distance | | >5.0 | mm |
| Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11)) | СТІ | 175 | |
| Material group (DIN EN 60664-1 VDE0110 Part 1) | | III a | |
| Storage temperature range | Tstg | -55 to +150 | °C |
| Operating temperature range | TA | -55 to +110 | °C |
| Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$ $V_{IO} = 500 \text{ V dc at } T_A \text{ MAX. at least } 100^{\circ}\text{C}$ | Ris MIN. Ris MIN. | 10 ¹² 10 ¹¹ | Ω Ω |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature | Tsi | 150 | °C |
| Current (input current IF, Psi = 0) Power (output or total power dissipation) Isolation resistance | lsi Psi | 300 500 | mA mW |
| V _{IO} = 500 V dc at T _A = Tsi | Ris MIN. | 10 ⁹ | Ω |

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|-----------------------|---|
| | • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. |
| | Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. |
| | 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. |
| | • Do not burn, destroy, cut, crush, or chemically dissolve the product. |
| | • Do not lick the product or in any way allow it to enter the mouth. |